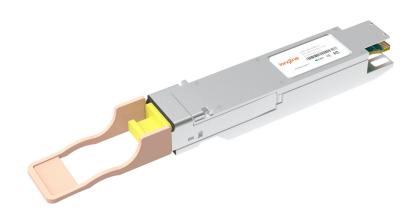


# QSFP-DD 400GBASE-DR4 1310nm 500m Silicon Photonics Transceiver

OSFP-SR8-400G-LL



## **Application**

- 400G Ethernet
- · InfiniBand Interconnects
- · Data Center and Enterprise Networking

## **Features**

- Compliant with QSFP-DD MSA
- Four Parallel 1310nm Optical Lanes
- IEEE 802.3bs 400GBASE-DR4
   Specification Compliant
- Compliant with RoHS Requirement
- Up to 500m Transmission on Single Mode
   Fiber (SMF) with FEC
- 8x53.125Gb/s Electrical Interface (400GAUI-8)
- Data Rate 4\*106.25Gbps (PAM4) Optical Interface
- Case Temperature Range: 0 to 70°C
- Maximum Power Consumption 10W
- MPO-12 Connector
- Built-in Digital Diagnostic Functions
- · Laser Safety Class 1



# **Product Specifications**

# I. Absolute Maximum Ratings

| Parameter                   | Unit | Min  | Тур. | Max  | Note |
|-----------------------------|------|------|------|------|------|
| Storage Temperature         | °C   | -40  |      | 85   |      |
| Operating Relative Humidity | %    | 0    |      | 85   |      |
| Power Supply Voltage        | V    | -0.5 |      | 3.63 |      |

# **II. Recommended Operating Conditions**

| Parameter                | Unit | Min   | Тур.   | Max   | Note |
|--------------------------|------|-------|--------|-------|------|
| Storage Temperature      | °C   | 0     |        | 70    |      |
| Power Supply Voltage     | V    | 3.135 | 3.3    | 3.465 |      |
| Power Consumption        | W    |       |        | 10    |      |
| Pre-FEC Bit Error Ratio  |      |       | 2.4E-4 |       |      |
| Post-FEC Bit Error Ratio |      |       | 1E-12  |       | 1    |
| Link Distance            | m    | 2     |        | 500   | 2    |

## Note:

<sup>1.</sup> FEC is provided by host system;

<sup>2.</sup> FEC is required on host system to support maximum distance.



# **III. Electrical Characteristics**

| Parameter                         | Unit    | Min | Тур.          | Max  | Note |  |  |  |
|-----------------------------------|---------|-----|---------------|------|------|--|--|--|
| Transmitter                       |         |     |               |      |      |  |  |  |
| Signaling Rate, each Lane         | GBd     | 26  | .5625 ± 100 p | ppm  | TP1  |  |  |  |
| Data Input Swing Differential/TX  | mV      | 85  | -             | 1600 |      |  |  |  |
| Data Differential Impedance       | Ω       | 90  | 100           | 110  |      |  |  |  |
|                                   | Receive | er  |               |      |      |  |  |  |
| Signaling Rate, each Lane         | GBd     | 26  | .5625 ± 100 p | ppm  | TP4  |  |  |  |
| Data Output Swing Differential/RX | mV      |     | -             | 900  |      |  |  |  |
| Data Differential Impedance       | Ω       | 90  | 100           | 110  |      |  |  |  |

# IV. Optical Characteristics (Under the Recommended Operating Environment)

| Parameter   | Unit        | Min    | Тур.           | Max    | Note |
|---|-------------|--------|----------------|--------|------|
|   | Transmitter |        |                |        |      |
| Signaling rate, each lane                                   | GBd         | 53     | 3.125 ± 100 pj | om     | PAM4 |
| TX Central Wavelength                                       | nm          | 1304.5 | 1310           | 1317.5 |      |
| Side-mode Suppression Ratio (SMSR)                          | dB          | 30     |                |        |      |
| Average Launch Power, each lane                             | dBm         | -2.9   |                | 4      | 1    |
| Outer Optical Modulation Amplitude<br>(OMAouter), each lane | dBm         | -0.8   |                | 4.2    | 2    |



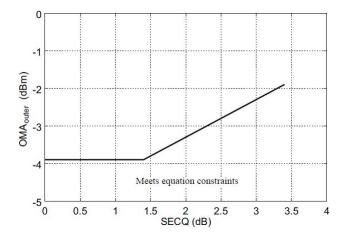
| Parameter   | Unit              | Min    | Тур.                       | Max           | Note |
|---|-------------------|--------|----------------------------|---------------|------|
| Launch Power in OMAouter minus TDECQ, each Lane(min)  | dBm               | -2.2   |                            |               |      |
| Transmitter and Dispersion Eye Closure for PAM4 (TDECQ), each lane (max)                    | dB                |        |                            | 3.4           | 3    |
| Average Launch Power of OFF<br>Transmitter, each lane (max)                                 | dBm               |        |                            | -15           |      |
| Extinction Ratio, each lane (min)   | dB                | 3.5    |                            |               |      |
| Optical Return Loss Tolerance (max)   | dB                |        |                            | 21.4          |      |
| RIN21.4OMA (max)  | dB/Hz             |        |                            | -136          |      |
| Transmitter Reflectance (max)   | dB                |        |                            | -26           |      |
|   | Receiver          |        |                            |               |      |
| Signaling Rate, each lane   | Gbps              | 5:     | 3.125 ± 100 p <sub>l</sub> | om            | PAM4 |
|   |                   |        |                            |               |      |
| RX Central Wavelength   | nm                | 1304.5 | 1310                       | 1317.5        |      |
| RX Central Wavelength  Damage Threshold (min)   | nm                | 1304.5 | 1310                       | 1317.5        | 4    |
|   |                   |        | 1310                       | 1317.5<br>4.0 | 4 5  |
| Damage Threshold (min)  | dBm               | 5      | 1310                       |               |      |
| Damage Threshold (min)  Average Receive Power per Lane                                      | dBm<br>dBm        | 5      | 1310                       | 4.0           |      |
| Damage Threshold (min)  Average Receive Power per Lane  Receiving Power (OMAouter) per Lane | dBm<br>dBm<br>dBm | 5      | 1310 Equation (1)          | 4.0           |      |



| Parameter  | Unit | Min. | Тур. | Max. | Note |  |  |  |  |
|--|------|------|------|------|------|--|--|--|--|
| Conditions of Stressed Receiver Sensitivity Test         |      |      |      |      |      |  |  |  |  |
| Stressed Eye Closure for PAM4 (SECQ),<br>lane under test | dB   |      | 3.4  |      | 8    |  |  |  |  |
| OMA outer of each aggressor lane                         | dBm  |      |      | 4.2  |      |  |  |  |  |
| LOS Assert   | dBm  | -15  |      |      |      |  |  |  |  |
| LOS De-Assert  | dBm  |      |      | -8.9 |      |  |  |  |  |
| LOS Hysteresis   | dB   | 0.5  |      |      |      |  |  |  |  |

#### Note:

- 1. Average launch power, each lane (min) is informative and not the principal indicator of signal strength. A transmitter with launch power below this value cannot be compliant; however, a value above this does not ensure compliance;
- 2. Even if the TDECQ < 1.4dB for an extinction ratio of  $\geq$  5dB or TDECQ < 1.1dB for an extinction ratio of < 5dB, the OMAouter (min) must exceed the minimum value specified here;
- 3. Ceq is a coefficient defined in IEEE Std 802.3-2018 clause 121.8.5.3 which accounts for reference equalizer noise enhancement;
- 4. Average receive power, each lane (min) is informative and not the principal indicator of signal strength. A received power below this value cannot be compliant; however, a value above this does not ensure compliance;
- 5. The receiver shall be able to tolerate, without damage, continuous exposure to a modulated optical input signal having this power level on one lane. The receiver does not have to operate correctly at this input power;
- 6. Receiver sensitivity (OMAouter), each lane (max) is informative and is defined for a transmitter with a value of SECQ up to 3.4 dB. It should meet Equation: RS=max (-3.9, SECQ-5.3), where RS is the receiver sensitivity, and SECQ is the SECQ of the transmitter used to measure the receiver sensitivity. which is illustrated in the Figure;

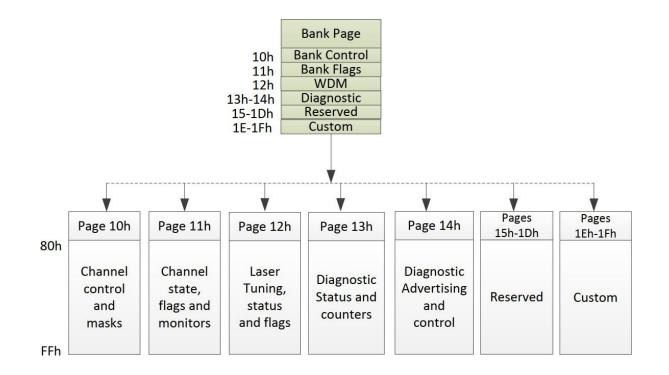


- 7. Measured with conformance test signal at TP3 for the BER equal to 2.4E-4;
- 8. These test conditions are for measuring stressed receiver sensitivity. They are not characteristics of the receiver.



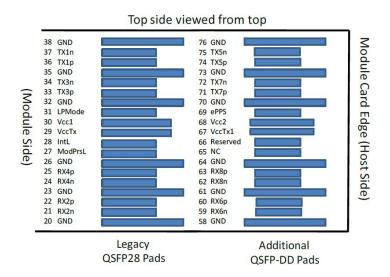
# **V. Digital Diagnostic Functions**

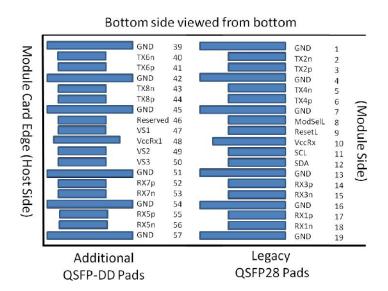
| Parameter              | Unit | Error | Note         |
|------------------------|------|-------|--------------|
| Temperature Monitor    | °C   | ±3    | 1LSB=1/256°C |
| Supply Voltage Monitor | V    | ± 0.1 | 1LSB=100uV   |
| Bias Current Monitor   | mA   | ±10%  | 1LSB=2uA     |
| TX Power Monitor       | dBm  | ±3    | 1LSB=0.1uW   |
| RX Power Monitor       | dBm  | ±3    | 1LSB=0.1uW   |





# VI. Pin Assignment and Description





| Pad | Logic | Symbol | Description                         | Plug Sequence | Notes |
|-----|-------|--------|-------------------------------------|---------------|-------|
| 1   |       | GND    | Ground                              | 1B            | 1     |
| 2   | CML-I | Tx2n   | Transmitter Inverted Data Input     | 3B            |       |
| 3   | CML-I | Tx2p   | Transmitter Non-Inverted Data Input | 3B            |       |
| 4   |       | GND    | Ground                              | 1B            | 1     |
| 5   | CML-I | Tx4n   | Transmitter Inverted Data Input     | 3B            |       |



| Pad | Logic      | Symbol  | Description                         | Plug Sequence | Notes |
|-----|------------|---------|-------------------------------------|---------------|-------|
| 6   | CML-I      | Tx4p    | Transmitter Non-Inverted Data Input | 3B            |       |
| 7   |            | GND     | Ground                              | 1B            | 1     |
| 8   | LVTTL-I    | ModSelL | Module Select                       | 3B            |       |
| 9   | LVTTL-I    | ResetL  | Module Reset                        | 3B            |       |
| 10  |            | VccRx   | +3.3V Power Supply Receiver         | 2В            | 2     |
| 11  | LVCMOS-I/O | SCL     | 2-wire Serial Interface Clock       | 3B            |       |
| 12  | LVCMOS-I/O | SDA     | 2-wire Serial Interface Data        | 3B            |       |
| 13  |            | GND     | Ground                              | 1B            | 1     |
| 14  | CML-O      | Rx3p    | Receiver Non-Inverted Data Output   | 3В            |       |
| 15  | CML-O      | Rx3n    | Receiver Inverted Data Output       | 3B            |       |
| 16  |            | GND     | Ground                              | 1B            | 1     |
| 17  | CML-O      | Rx1p    | Receiver Non-Inverted Data Output   | 3B            |       |
| 18  | CML-O      | Rx1n    | Receiver Inverted Data Output       | 3B            |       |
| 19  |            | GND     | Ground                              | 1B            | 1     |
| 20  |            | GND     | Ground                              | 1B            | 1     |
| 21  | CML-O      | Rx2n    | Receiver Inverted Data Output       | 3B            |       |
| 22  | CML-O      | Rx2p    | Receiver Non-Inverted Data Output   | 3В            |       |
| 23  |            | GND     | Ground                              | 1B            | 1     |
| 24  | CML-O      | Rx4n    | Receiver Inverted Data Output       | 3B            |       |
| 25  | CML-O      | Rx4p    | Receiver Non-Inverted Data Output   | 3B            |       |



| Pad | Logic   | Symbol   | Description  | Plug Sequence | Notes |
|-----|---------|----------|--|---------------|-------|
| 26  |         | GND      | Ground   | 1B            | 1     |
| 27  | LVTTL-O | ModPrsL  | Module Present   | 3B            |       |
| 28  | LVTTL-O | IntL     | Interrupt  | 3B            |       |
| 29  |         | VccTx    | +3.3V Power Supply Transmitter   | 2B            | 2     |
| 30  |         | Vcc1     | +3.3V Power Supply   | 2B            | 2     |
| 31  | LVTTL-I | InitMode | Initialization Mode; In legacy QSFP applications, the InitMode pad is calledLPMODE | 3B            |       |
| 32  |         | GND      | Ground   | 1B            | 1     |
| 33  | CML-I   | Тх3р     | Transmitter Non-Inverted Data Input  | 3B            |       |
| 34  | CML-I   | Tx3n     | Transmitter Inverted Data Input  | 3B            |       |
| 35  |         | GND      | Ground   | 1B            | 1     |
| 36  | CML-I   | Tx1p     | Transmitter Non-Inverted Data Input  | 3B            |       |
| 37  | CML-I   | Tx1n     | Transmitter Inverted Data Input  | 3B            |       |
| 38  |         | GND      | Ground   | 1B            | 1     |
| 39  |         | GND      | Ground   | 1A            | 1     |
| 40  | CML-I   | Tx6n     | Transmitter Inverted Data Input  | 3A            |       |
| 41  | CML-I   | Тхбр     | Transmitter Non-Inverted Data Input  | 3A            |       |
| 42  |         | GND      | Ground   | 1A            | 1     |
| 43  | CML-I   | Tx8n     | Transmitter Inverted Data Input  | 3A            |       |
| 44  | CML-I   | Тх8р     | Transmitter Non-Inverted Data Input  | 3A            |       |
| 45  |         | GND      | Ground   | 1A            | 1     |



| Pad | Logic | Symbol   | Description                       | Plug Sequence | Notes |
|-----|-------|----------|-----------------------------------|---------------|-------|
| 46  |       | Reserved | For future use                    | 3A            | 3     |
| 47  |       | VS1      | Module Vendor Specific 1          | 3A            | 3     |
| 48  |       | VccRx1   | 3.3V Power Supply                 | 2A            | 2     |
| 49  |       | VS2      | Module Vendor Specific 2          | 3A            | 3     |
| 50  |       | VS3      | Module Vendor Specific 3          | 3A            | 3     |
| 51  |       | GND      | Ground                            | 1A            | 1     |
| 52  | CML-O | Rx7p     | Receiver Non-Inverted Data Output | 3A            |       |
| 53  | CML-O | Rx7n     | Receiver Inverted Data Output     | 3A            |       |
| 54  |       | GND      | Ground                            | 1A            | 1     |
| 55  | CML-O | Rx5p     | Receiver Non-Inverted Data Output | 3A            |       |
| 56  | CML-O | Rx5n     | Receiver Inverted Data Output     | 3A            |       |
| 57  |       | GND      | Ground                            | 1A            | 1     |
| 58  |       | GND      | Ground                            | 1A            | 1     |
| 59  | CML-O | Rx6n     | Receiver Inverted Data Output     | 3A            |       |
| 60  | CML-O | Rx6p     | Receiver Non-Inverted Data Output | 3A            |       |
| 61  |       | GND      | Ground                            | 1A            | 1     |
| 62  | CML-O | Rx8n     | Receiver Inverted Data Output     | 3A            |       |
| 63  | CML-O | Rx8p     | Receiver Non-Inverted Data Output | 3A            |       |
| 64  |       | GND      | Ground                            | 1A            | 1     |
| 65  |       | NC       | No Connect                        | 3A            | 3     |



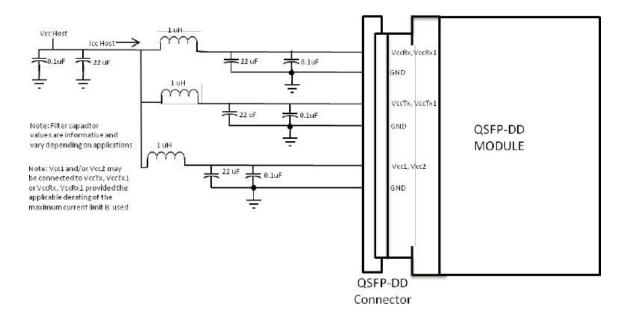
| Pad | Logic | Symbol   | Description                         | Plug Sequence | Notes |
|-----|-------|----------|-------------------------------------|---------------|-------|
| 66  |       | Reserved | For future use                      | 3A            | 3     |
| 67  |       | VccTx1   | 3.3V Power Supply                   | 2A            | 2     |
| 68  |       | Vcc2     | 3.3V Power Supply                   | 2A            | 2     |
| 69  |       | Reserved | For future use                      | 3A            | 3     |
| 70  |       | GND      | Ground                              | 1A            | 1     |
| 71  | CML-I | Тх7р     | Transmitter Non-Inverted Data Input | 3A            |       |
| 72  | CML-I | Tx7n     | Transmitter Inverted Data Input     | 3A            |       |
| 73  |       | GND      | Ground                              | 1A            | 1     |
| 74  | CML-I | Тх5р     | Transmitter Non-Inverted Data Input | 3A            |       |
| 75  | CML-I | Tx5n     | Transmitter Inverted Data Input     | 3A            |       |
| 76  |       | GND      | Ground                              | 1A            | 1     |

### Note:

- 1. QSFP-DD uses common ground (GND) for all signals and supply (power). All are common within the QSFP-DD module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal- common ground plane; 2. VccRx, VccRx1, Vcc1, Vcc2, VccTx and VccTx1 shall be applied concurrently. Requirements defined for the host side of the Host Card Edge Connector are listed in Table 6. VccRx, VccRx1, Vcc1, Vcc2, VccTx and VccTx1 may be internally connected within the module in any combination. The connector Vcc pins are each rated for a maximum current of 1000 mA;
- 3. All Vendor Specific, Reserved and No Connect pins may be terminated with 50 ohms to ground on the host. Pad 65 (No Connect) shall be left unconnected within the module. Vendor specific and Reserved pads shall have an impedance to GND that is greater than 10 kOhms and less than 100 pF;
- 4. Plug Sequence specifies the mating sequence of the host connector and module. The sequence is 1A, 2A, 3A, 1B, 2B, 3B. (see Figure 2 for pad locations) Contact sequence A will make, then break contact with additional QSFP-DD pads. Sequence 1A, 1B will then occur simultaneously, followed by 2A, 2B, followed by 3A,3B.



# VII. Recommended Power Supply Filter



## VIII. Mechanical Outlines

